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N-Type Polymeric Organic Flash Memory Device: Effect of Reduced Graphene Oxide Floating Gate

B. Hafsi^{1, 2, a}, A. Boubaker², D. Guerin¹, S. Lenfant¹, A. Kalboussi², K. Lmimouni¹

Abstract. In this paper, n type nonvolatile memory devices were fabricated by implanting a bilayer (rGO sheets/Au NP) floating gates, using n-type polymer semiconductor, poly $\{[N, N' \text{ bis (2octyldodecyl)} - \text{naphthalene-1}, 4, 5, 8 - \text{bis (dicarboximide)-2,6-diyl}] - \text{alt - 5,5' - (2, 2' \text{ bithiophene })} [P(NDI2OD-T2)_n]. In the developed organic field effect transistor memory devices, electrons are trapped/ detrapped in rGO sheet/Au NP's nano-floating gates by controlling the charge carrier density in the active layer through back gate bias control. The devices showed interesting non-volatile memory properties with a large memory window of ~34 V, a programming-reading-erasing cycling endurance of <math>10^3$ times and most importantly, an improved retention time characteristics estimated by extrapolation (longer than the technological requirement of commercial memory devices (>10 years)). This approach provides a great potential for fabricating high-performances organic nano-floating gate memory devices and opens up a new way for the development of next-generation non-volatile memory devices.

Key words. Field-effect transistor, PolyeraTM N2200, self-assembled monolayer, flash memory, reduce graphene oxide, gold nanoparticles

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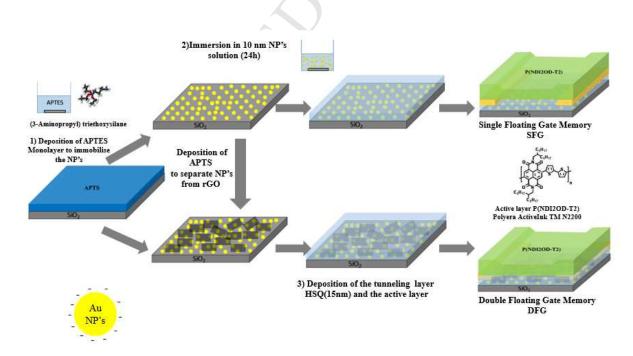


Figure 1. Fabrication process of the n-type organic memory devices. Gate and source/drain electrodes were thermally evaporated. The active layer [P (NDI2OD-T2)_n] and the tunneling dielectric layer (HSQ) and were deposited by spin-coating. The floating gate layer is composed of Au NP's and reduced graphene oxide.

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